

/ Descriptions

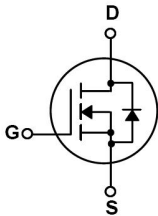
/ Features

1 1

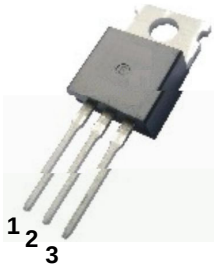
/ Applications

DC/DC

/ Equivalent Circuit



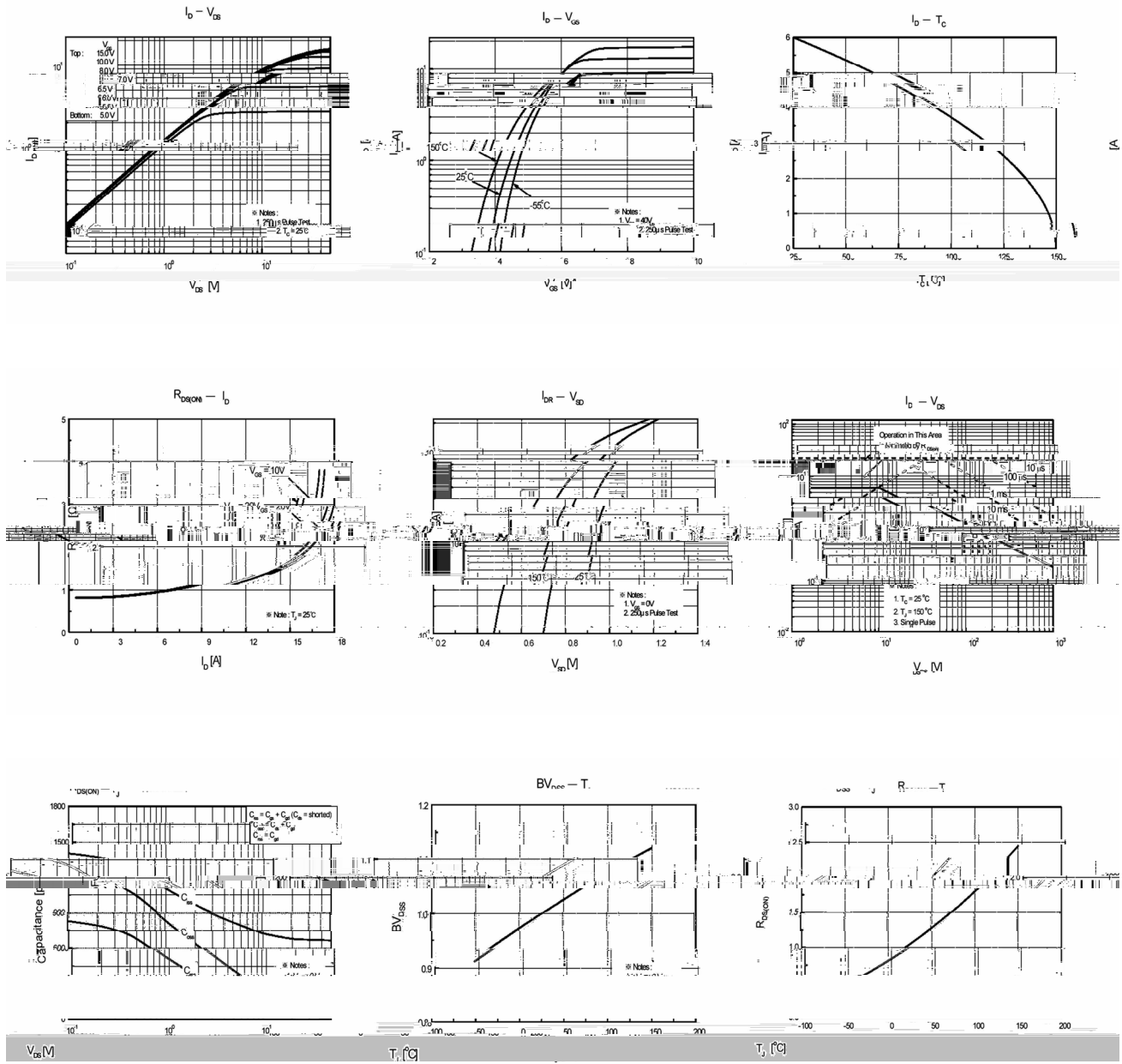
/ Pinning



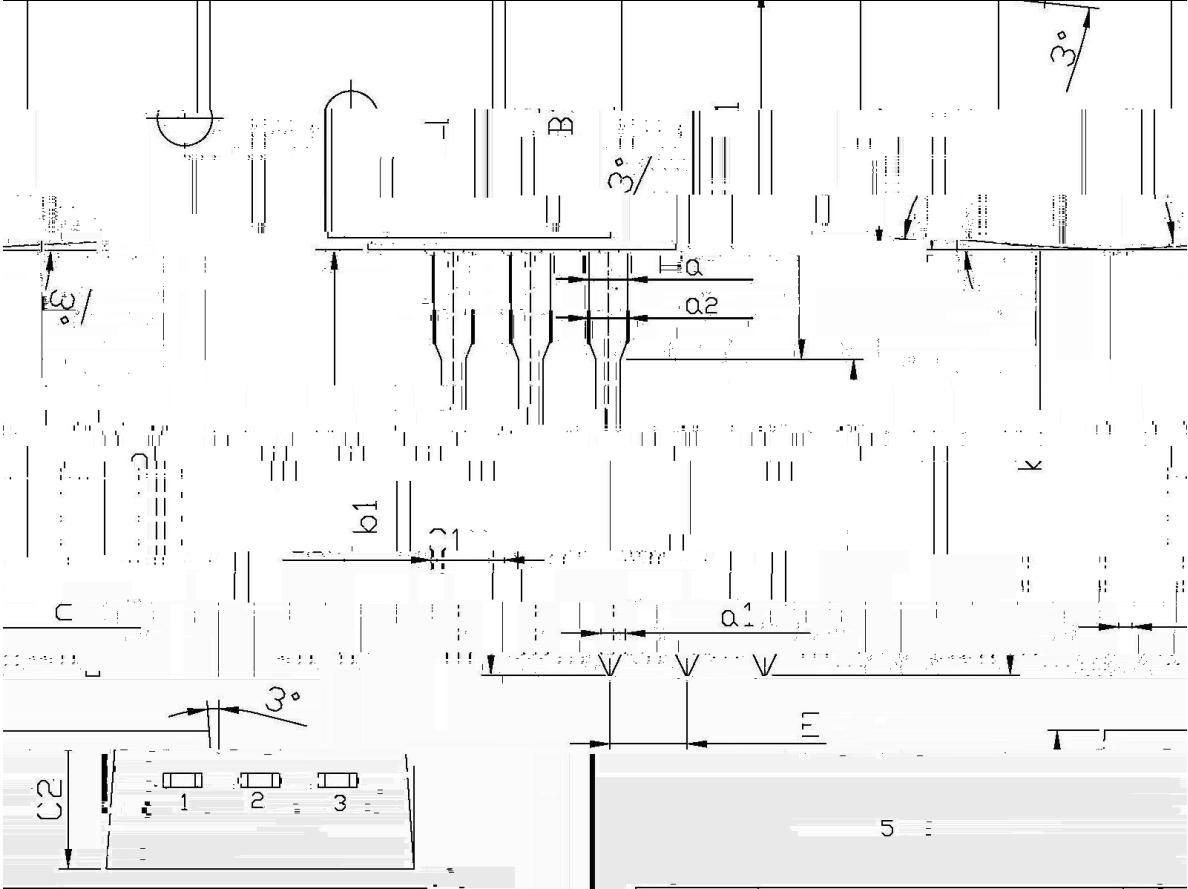
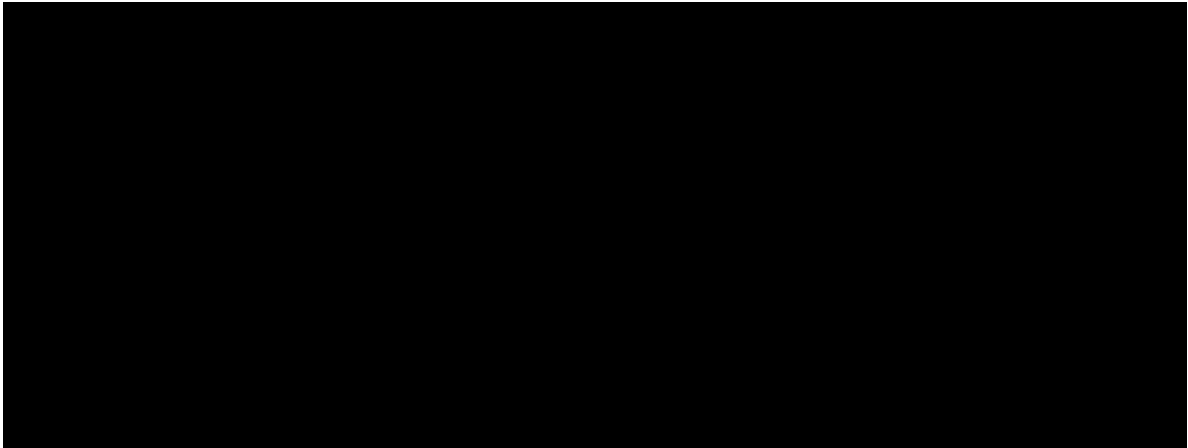
/ h_{FE} Classifications & Marking

	°C		

/ Electrical Characteristic Curve

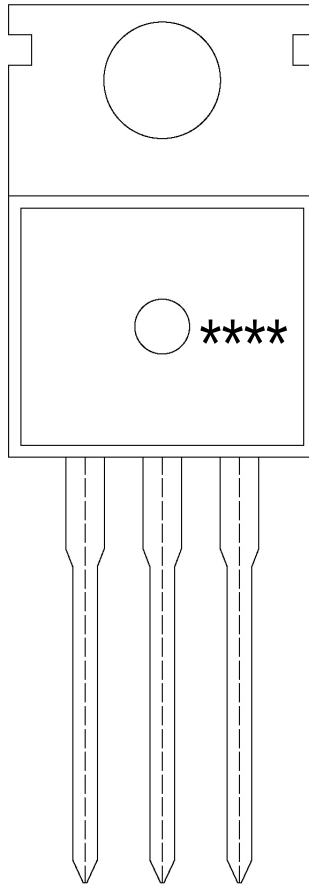


/ Package Dimensions

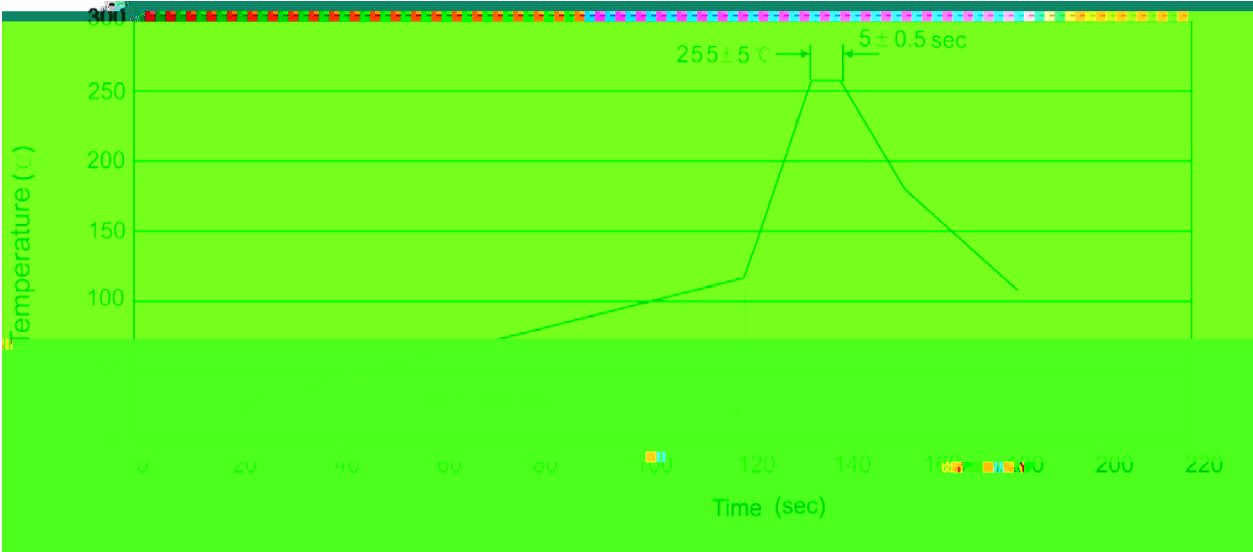


Dimensions in Millimeters		Dimensions in Millimeters	
Symbol	Min	Symbol	Min
A	9.8	C	1.2
B	10.2	D	1.4
C	15.7	E	1.3
D	12.6	F	1.3
E	13.6	G	1.3
F	10.6	H	1.3
G	10.6	I	1.3
H	10.6	J	1.3
I	10.6	K	1.3
J	10.6	L	1.3
K	10.6	M	1.3
L	10.6	N	1.3
M	10.6	O	1.3
N	10.6	P	1.3
O	10.6	Q	1.3
P	10.6	R	1.3
Q	10.6	S	1.3
R	10.6	T	1.3
S	10.6	U	1.3
T	10.6	V	1.3
U	10.6	W	1.3
V	10.6	X	1.3
W	10.6	Y	1.3
X	10.6	Z	1.3
Y	10.6		
Z	10.6		

/ Marking Instructions



() / Temperature Profile for Dip Soldering(Pb-Free)



± ± ± ±

/ Resistance to Soldering Heat Test Conditions

± ± °C

/ Packaging SPEC.